## CRMGGL1011A

### N-Channel 100V, 11mΩ Typ. Power MOSFET

### **Description**

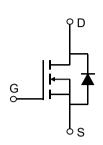
#### **Features**

• 100V, 50A

$$R_{DS(ON)}$$
 Typ = 11m $\Omega$  @  $V_{GS}$  = 10 $V$ 

$$R_{DS(ON)}$$
 Typ =  $15m\Omega$  @  $V_{GS}$  =  $4.5V$ 

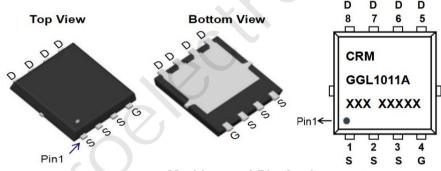
- Advanced Split Gate Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





## **Application**

- Load Switch
- PWM Application
- Power Management



**Marking and Pin Assignment** 

#### **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGL1011A	CRMGGL1011A	PDFN5x6-8L	TAPING	13"	5000	50000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Value	Units	
$V_{DS}$	Drain-to-Source Voltage		100	V
$V_{GS}$	Gate-to-Source Voltage	±20	V	
	Continuous Drain Current	T <sub>C</sub> = 25°C	50	Α
I <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> = 100°C	30	Α
I <sub>DM</sub>	Pulsed Drain Current (1)		200	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		60	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	71.4	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1.75	°C/W
$T_{J}$ , $T_{STG}$	Junction & Storage Temperature Range		-55 to 150	°C

1

# CRMGGL1011A

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### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1.0	μΑ
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.8	2.4	V
В	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10V, I_D = 30A$	-	11	14.3	mΩ
$R_{DS(ON)}$		$V_{GS} = 4.5V, I_D = 20A$	-	15	19.5	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1092	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V$ , $V_{DS} = 50V$ , f = 1MHz	X-\	298	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 - 1101112		6	-	pF
$Q_g$	Total Gate Charge		<b>U</b> -	19	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_{D} = 25A$	-	6.5	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 23/1	-	3	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime		-	7	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 50V$	-	40	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 25A$ , $R_{GEN} = 3\Omega$	-	23	-	ns
$t_f$	Turn-Off Fall Time		-	9	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	50	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	200	Α
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 254 dildt - 4004/:	-	55	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 25A$ , di/dt = 100A/us	-	64	-	nC
	T 1					

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =50V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =15.5A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

# **Typical Performance Characteristics**

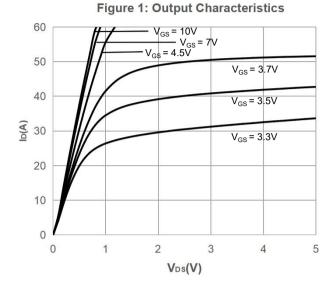


Figure 3: On-resistance vs. Drain Current

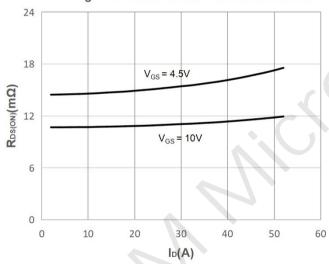


Figure 5: Gate Charge Characteristics

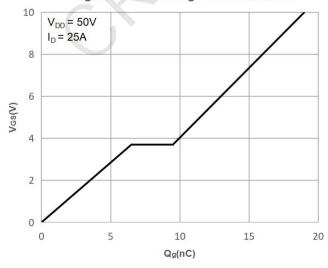


Figure 2: Typical Transfer Characteristics

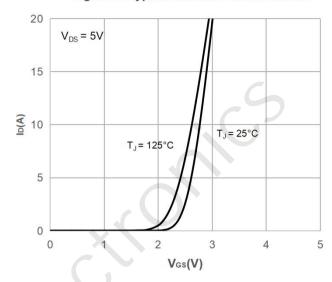


Figure 4: Body Diode Characteristics

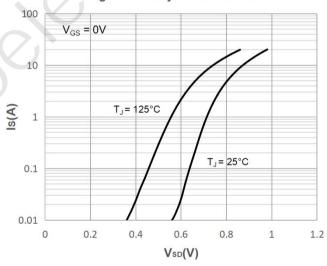
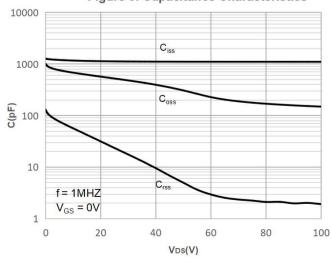


Figure 6: Capacitance Characteristics



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# **Typical Performance Characteristics**

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

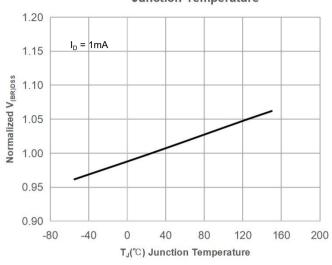


Figure 9: Maximum Safe Operating Area

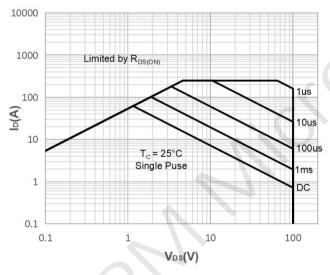


Figure 11: Normalized Maximum Transient

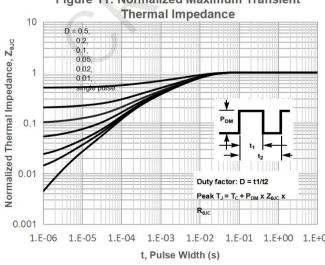


Figure 8: Normalized on Resistance vs. Junction Temperature

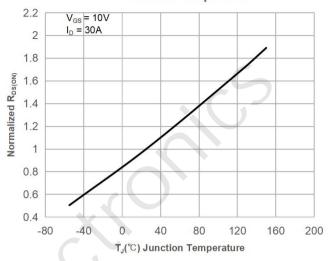


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

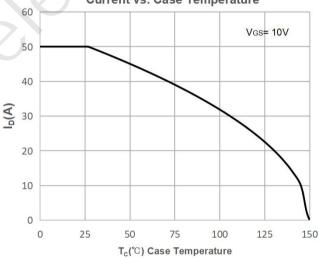
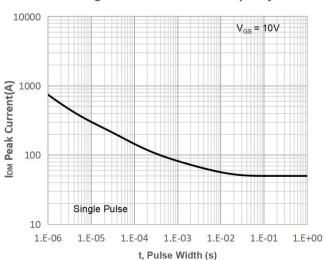


Figure 12: Peak Current Capacity



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### **Test Circuit**

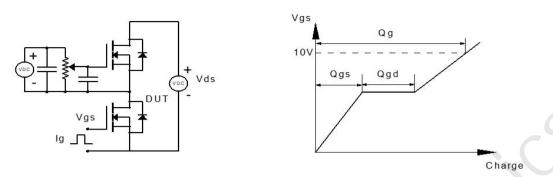


Figure 1: Gate Charge Test Circuit & Waveform

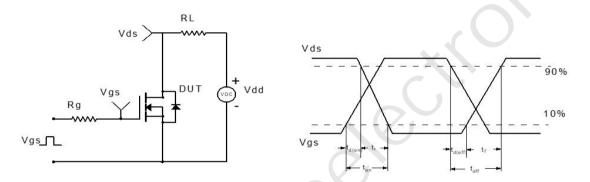


Figure 2: Resistive Switching Test Circuit & Waveform

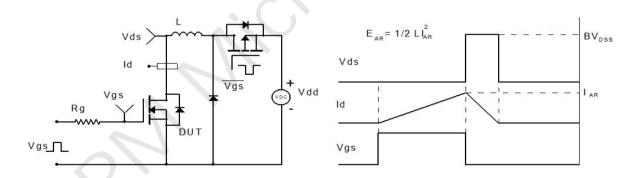


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

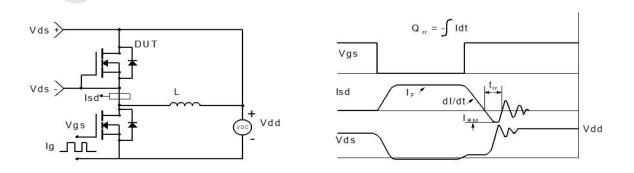
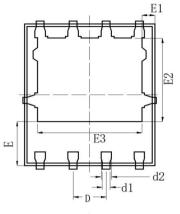


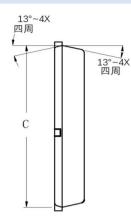
Figure 4: Diode Recovery Test Circuit & Waveform

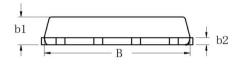
## CRMGGL1011A

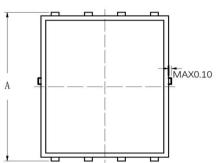
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### Package Mechanical Data(PDFN5x6-8L)









	COMMON DIM	MENSION (MM)	
PKG	PDFN 5×6-8L		
SYMBOL	MIN	TYP	MAX
А	6.000	6.100	6.200
В	4.875	4.900	4.925
b1	0.975	1.000	1.025
b2	0.246	0.254	0.262
С	5.775	5.800	5.825
D	1.245	1.270	1.295
d1	0.275	0.300	0.325
d2	0.375	0.400	0.425
E	1.725	1.775	1.825
E1	0.395	0.445	0.495
E2	3.425	3.475	3.525
E3	3.960	4.010	4.060

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